

09/913334

JC03 Rec'd PCT/PTO 13 AUG 2000

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Application Information

Title Line One:: ETCHANT, ETCHING METHOD AND
Title Line Two:: SEMICONDUCTOR SILICON WAFER
Total Drawing Sheets:: 2
Docket Number:: 110386

Continuity Information

>This application is a:: 371 of
Application One:: PCT/JP00/09185
Filing Date:: December 25, 2000

Prior Foreign Applications

Foreign Application One:: 11-374052
Filing Date:: December 28, 1999
Country:: Japan
Priority Claimed:: yes

Assignee Information

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